

Title of Change:	NLPS591MNTWG – datasheet revision.					
Effective date:	1 July 2019					
Contact information:	Contact your local ON Semiconductor Sales Office or < <u>Murarasu.TraianTudor@onsemi.com&gt;</u>					
Type of notification:	This Product Bulletin is for notification purposes only. ON Semiconductor will proceed with implementation of this change upon publication of this Product Bulletin.					
Change Category:	🔲 Wafer Fab	Assembly Chan	ge 🔲 Te	est Change	<ul> <li>Other</li> </ul>	Datasheet revision
Change Sub-Category(s): <ul> <li>Manufacturing Site Addition</li> <li>Manufacturing Site Transfer</li> <li>Manufacturing Process Chan</li> </ul>	Manufacturing Site Addition			<ul> <li>Datasheet/Product Doc change</li> <li>Shipping/Packaging/Marking</li> <li>Other:</li> </ul>		
Sites Affected:	ted: ON Semiconductor Sites: None			External Foundry/Subcon Sites: None		
Description and Purpose:						
<ul> <li>Datasheet revision required to update the document with the correct OPN name (old OPN name: NLPS591MTTBG, new OPN name: NLPS591MTTBG).</li> <li>The change will not impact form, fit, or function of the product.</li> <li>The required change can be referred to from below image.</li> </ul> ON Semiconductor <sup>®</sup>						
www.onsemi.com			www.onsemi.com			
1 WQFN16 MT SUFFIX CASE 488AP			WQFN16 MN SUFFIX CASE 488AP			
MARKING DIAGRAM			MARKING DIAGRAM			
M = Date	M = Date Code		AJ = Specific Device Code M = Date Code • = Pb-Free Package			
						1
Device Pac	skage Shipping⊺		Device	Package	Shipping <sup>†</sup>	



## List of Affected Part:

Note: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the PCN Customized Portal.

• NLPS591MNTWG